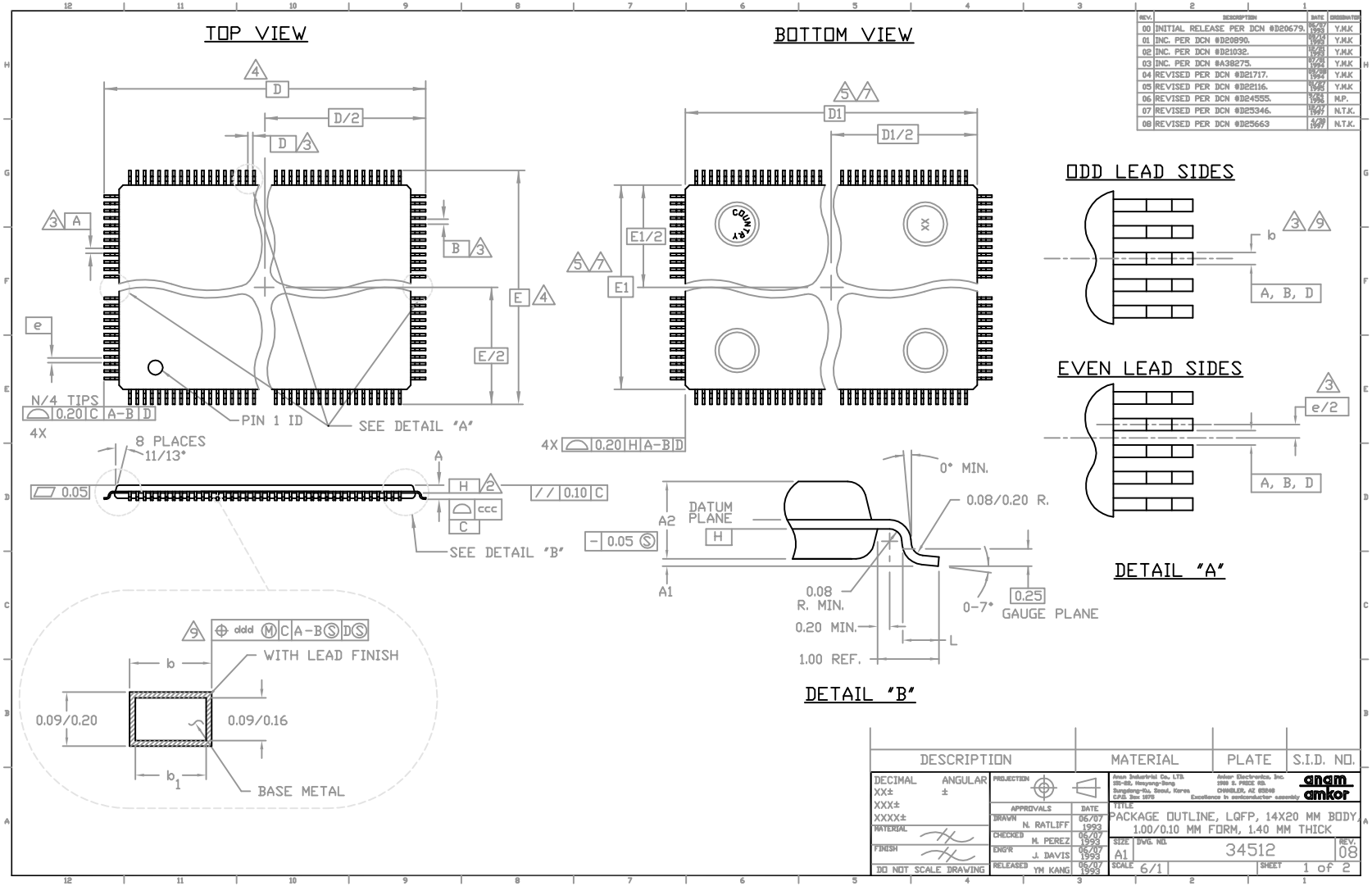
REV.	DESCRIPTION	DATE	COORDINATOR
00	INITIAL RELEASE PER DCN #D20679.	06/07 1993	Y.M.K
01	INC. PER DCN #D20890.	11/29 1993	Y.M.K
02	INC. PER DCN #D21032.	11/29 1993	Y.M.K
03	INC. PER DCN #A38275.	11/22 1994	Y.M.K
04	REVISED PER DCN #D21717.	11/29 1994	Y.M.K
05	REVISED PER DCN #D22116.	11/29 1994	Y.M.K
06	REVISED PER DCN #D24555.	11/03 1996	M.P.
07	REVISED PER DCN #D25346.	10/27 1997	N.T.K.
08	REVISED PER DCN #D25663	4/29 1997	N.T.K.



DESCRIPTION	MATERIAL	PLATE	S.I.D. NO.

DECIMAL XX± XXX± XXXX± ANGULAR ±

MATERIAL

FINISH

DO NOT SCALE DRAWING

PROJECTION

APPROVALS		DATE
DRAWN	N. RATLIFF	06/07 1993
CHECKED	M. PEREZ	06/07 1993
ENGR	J. DAVIS	06/07 1993
RELEASED	YM KANG	06/07 1993

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Excellence in semiconductor assembly

anam amkor

TITLE
PACKAGE OUTLINE, LQFP, 14X20 MM BODY, 1.00/0.10 MM FORM, 1.40 MM THICK

SIZE A1 | DWG. NO. 34512 | REV. 08

SCALE 6/1 | SHEET 1 of 2